





# Feature-Rich PCIe Gen 5 Enterprise Storage Solutions

The Miphi X200 exists to support your diverse requirements in a single series. X200 delivers both single-port and dual-port modes while shipping in U.2 2.5" and E3.S form factors to give your data center reliable, and predictable performance that exceeds industry standards.



#### **Product Features**

- PCle 5.0 1x4 / 2x2 (Dual port)
- NVMe 2.0
- · Capacity up to 30.72TB
- Form Factor: U.2 / E3.S
- DWPD: 1 / 3
- 128 Namespaces
- Power Loss Protection (PLP)
- ISE, TCG Opal 2.0 Support
- AES-XTS 256-bit Encryption
- · End-to-End Data Path Protection
- Metadata Protection
- SECDED
- Sanitize
- NVMe-MI (Management Interface)
- SMBus

#### **Sequential Performance**

Read 14,800 MB/s

Read 8,700K MB/s

#### **Random Performance**

Read 3,000K IOPS

Write 900K IOPS



## Solution - X200E

Form Factor			U.2					
Capacity <sup>(1)</sup>	1.6TB	3.2TB	6.4TB	12.8TB	25.6TB			
Interface	PCIe 5.0 1x4, 2x2	PCle 5.0 1x4, 2x2	PCle 5.0 1x4, 2x2	PCle 5.0 1x4, 2x2	PCle 5.0 1x4, 2x2			
NVMe	2.0	2.0	2.0	2.0	2.0			
NAND Flash	3D TLC	3D TLC	3D TLC	3D TLC	3D TLC			
	Performance(2,3,4,6)							
Sequential Read(MB/s)	14,800	14,800	14,800	14,800	14,000 (Est.)			
Sequential Write(MB/s)	4,300	8,600	8,700	8,350	7,500 (Est.)			
4K Random Read(IOPS)	2400K	3,000K	3,000K	3,000K	2,300K (Est.)			
16K Random Write(IOPS)	400K	800K	900K	900K	630K (Est.)			
Read Latency (Typ., µs)	60	60	60	60	60			
Write Latency (Typ., µs)	10	10	10	10	10			
	Powe	er Consumption <sup>(5,6)</sup>						
Active (W)	<25	<25	<25	<25	<25			
Idle (W)	5	5	5	5	5			
	End	urance/Reliability						
DWPD	3	3	3	3	3			
UBER	< 1 sector per	< 1 sector per	< 1 sector per	< 1 sector per	< 1 sector per			
ODLIN	10 <sup>18</sup> bits read	10 <sup>18</sup> bits read	10 bits read	10 bits read	10 <sup>18</sup> bits read			
MTBF (million hours)	2.5	2.5	2.5	2.5	2.5			
Limited Warranty (years)	5	5	5	5	5			
	Temperature							
Operating Temp. (°C)	0 - 70	0 - 70	0 - 70	0 - 70	0 - 70			
Non-Operating Temp. (°C)	-40 - 85	-40 - 85	-40 - 85	-40 - 85	-40 - 85			
	Ph	ysical Dimension						
Length (mm)	100.10	100.10	100.10	100.10	100.10			
Width (mm)	69.85	69.85	69.85	69.85	69.85			
Height (mm)	15.00	15.00	15.00	15.00	15.00			
Weight (g)	188	199	201	168	<250			

<sup>(7)</sup> The results of DWPD are obtained in compliance with JESD219A Standards.



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<sup>(1)</sup> The product is still in the early development stage, all values provided are based on estimation.
(2) 1 TB = 1012 bytes.
(3) Sequential Performance is based on FIO on Linux, 128KB, with QD=32, 1 worker, and test drive set as secondary.
(4) Random Performance is based on FIO on Linux, 4KB data size, QD=32, 16 workers.
(5) Latency is measured with random workloads based on FIO on Linux, 4KB data size, QD=1, 1 worker.
(6) Power consumption (Maximum RMS) is measured during the sequential read/write and random read/write operations performed by iometer with the conditions described in (2)(3).

## Solution - X200E

Form Factor		E3	.s			
Capacity(1)	1.6TB	3.2TB	6.4TB	12.8TB		
Interface	PCIe 5.0 1x4, 2x2	PCIe 5.0 1x4, 2x2	PCIe 5.0 1x4, 2x2	PCle 5.0 1x4, 2x2		
NVMe	2.0	2.0	2.0	2.0		
NAND Flash	3D TLC	3D TLC	3D TLC	3D TLC		
Performance <sup>(2,3,4,6)</sup>						
Sequential Read(MB/s)	14,800	14,800	14,800	14,800		
Sequential Write(MB/s)	4,300	8,600	8,700	8,350		
4K Random Read(IOPS)	2,400K	3,000K	3,000K	3,000K		
16K Random Write(IOPS)	400K	800K	900K	900K		
Read Latency (Typ., µs)	60	60	60	60		
Write Latency (Typ., µs)	10	10	10	10		
	Power Con	nsumption <sup>(5,6)</sup>				
Active (W)	<25	<25	<25	<25		
Idle (W)	5	5	5	5		
	Enduranc	e/Reliability				
DWPD(7)	3	3	3	3		
UBER	< 1 sector per	< 1 sector per	< 1 sector per	< 1 sector per		
	10 bits read	10 bits read	10 bits read	10 bits read		
MTBF (million hours)	2.5	2.5	2.5	2.5		
Limited Warranty (years)	5	5	5	5		
	Tem	perature				
Operating Temp. (°C)	0 - 70	0 - 70	0 - 70	0 - 70		
Non-Operating Temp. (°C)	-40 - 85	-40 - 85	-40 - 85	-40 - 85		
	Physical	Dimension				
Length (mm)	112.75	112.75	112.75	112.75		
Width (mm)	76.00	76.00	76.00	76.00		
Height (mm)	7.50	7.50	7.50	7.50		
Weight (g)	TBD	TBD	TBD	TBD		

<sup>(7)</sup> The results of DWPD are obtained in compliance with JESD219A Standards.



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(4) Random Performance is based on FIO on Linux, 4KB data size, QD=32, 16 workers.
(5) Latency is measured with random workloads based on FIO on Linux, 4KB data size, QD=1, 1 worker.
(6) Power consumption (Maximum RMS) is measured during the sequential read/write and random read/write operations performed by iometer with the conditions described in (2)(3).

## Solution - X200P

Form Factor			U.2					
Capacity(1)	1.92TB	3.84TB	7.68TB	15.36TB	30.72TB			
Interface	PCIe 5.0 1x4, 2x2	PCle 5.0 1x4, 2x2	PCle 5.0 1x4, 2x2	PCle 5.0 1x4, 2x2	PCle 5.0 1x4, 2x2			
NVMe	2.0	2.0	2.0	2.0	2.0			
NAND Flash	3D TLC	3D TLC	3D TLC	3D TLC	3D TLC			
	Performancé <sup>2,3,4,6)</sup>							
Sequential Read(MB/s)	14,800	14,800	14,800	14,800	14,000 (Est.)			
Sequential Write(MB/s)	4,300	8,600	8,700	8,350	7,500 (Est.)			
4K Random Read(IOPS)	2,400K	3,000K	3,000K	3,000K	2,300K (Est.)			
16K Random Write(IOPS)	170K	380K	500K	500K	283K (Est.)			
Read Latency (Typ., µs)	60	60	60	60	60			
Write Latency (Typ., µs)	10	10	10	10	10			
	Powe	er Consumption <sup>(5,6)</sup>						
Active (W)	<25	<25	<25	<25	<25			
Idle (W)	5	5	5	5	5			
	End	urance/Reliability						
DWPD(7)	1	1	1	1	1			
UBER	< 1 sector per	< 1 sector per	< 1 sector per	< 1 sector per	< 1 sector per			
ODLIN	10 bits read	10 bits read	10 bits read	10 bits read	10 bits read			
MTBF (million hours)	2.5	2.5	2.5	2.5	2.5			
Limited Warranty (years)	5	5	5	5	5			
		Temperature						
Operating Temp. (°C)	0 - 70	0 - 70	0 - 70	0 - 70	0 - 70			
Non-Operating Temp. (°C)	-40 - 85	-40 - 85	-40 - 85	-40 - 85	-40 - 85			
	Ph	ysical Dimension						
Length (mm)	100.10	100.10	100.10	100.10	100.10			
Width (mm)	69.85	69.85	69.85	69.85	69.85			
Height (mm)	15.00	15.00	15.00	15.00	15.00			
Weight (g)	188	199	201	168	<250			

<sup>(7)</sup> The results of DWPD are obtained in compliance with JESD219A Standards.



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(5) Latency is measured with random workloads based on FIO on Linux, 4KB data size, QD=1, 1 worker.
(6) Power consumption (Maximum RMS) is measured during the sequential read/write and random read/write operations performed by iometer with the conditions described in (2)(3).

#### Solution - X200P

Form Factor		E3.9	S				
Capacity 1	1.92TB	3.84TB	7.68TB	15.36TB			
Interface	PCle 5.0 1x4, 2x2	PCIe 5.0 1x4, 2x2	PCIe 5.0 1x4, 2x2	PCle 5.0 1x4, 2x2			
NVMe	2.0	2.0	2.0	2.0			
NAND Flash	3D TLC	3D TLC	3D TLC	3D TLC			
	Performance(2,3,4,6)						
Sequential Read(MB/s)	14,800	14,800	14,800	14,800			
Sequential Write(MB/s)	4,300	8,600	8,700	8,350			
4K Random Read(IOPS)	2,400K	3,000K	3,000K	3,000K			
16K Random Write(IOPS)	170K	380K	500K	500K			
Read Latency (Typ., µs)	60	60	60	60			
Write Latency (Typ., μs)	10	10	10	10			
	Power Cor	nsumption <sup>(5,6)</sup>					
Active (W)	<25	<25	<25	<25			
Idle (W)	5	5	5	5			
	Enduranc	e/Reliability					
DWPD <sup>7</sup>	3	3	3	3			
UBER	< 1 sector per	< 1 sector per	< 1 sector per	< 1 sector per			
	10 bits read	10 bits read	10 bits read	10 bits read			
MTBF (million hours)	2.5	2.5	2.5	2.5			
Limited Warranty (years)	5	5	5	5			
	Tem	perature					
Operating Temp. (°C)	0 - 70	0 - 70	0 - 70	0 - 70			
Non-Operating Temp. (°C)	-40 - 85	-40 - 85	-40 - 85	-40 - 85			
	Physica	l Dimension					
Length (mm)	112.75	112.75	112.75	112.75			
Width (mm)	76.00	76.00	76.00	76.00			
Height (mm)	7.50	7.50	7.50	7.50			
Weight (g)	TBD	TBD	TBD	TBD			

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